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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	4MB (4M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 22x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mlcdlj-21

Table 1.3 List of Products (3/3)

Group	Part No.	Package	Code Flash Memory Capacity	RAM Capacity	Data Flash Memory Capacity	Operating Frequency (Max.)	Encryption Module	SDHI
RX64M	R5F564MFCDLK	PTLG0145KA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Not supported
	R5F564MFDDLK	PTLG0145KA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Available
	R5F564MFGDLK	PTLG0145KA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Not supported
	R5F564MFHDLK	PTLG0145KA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Available
	R5F564MLCDLJ	PTLG0100JA-A	4 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Not supported
	R5F564MLDDLJ	PTLG0100JA-A	4 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Available
	R5F564MLGDLJ	PTLG0100JA-A	4 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Not supported
	R5F564MLHDLJ	PTLG0100JA-A	4 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Available
	R5F564MJCDLJ	PTLG0100JA-A	3 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Not supported
	R5F564MJDDLJ	PTLG0100JA-A	3 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Available
	R5F564MJGDLJ	PTLG0100JA-A	3 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Not supported
	R5F564MJHDLJ	PTLG0100JA-A	3 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Available
	R5F564MGCDLJ	PTLG0100JA-A	2.5 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Not supported
	R5F564MGDDLJ	PTLG0100JA-A	2.5 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Available
	R5F564MGGDLJ	PTLG0100JA-A	2.5 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Not supported
	R5F564MGHDLJ	PTLG0100JA-A	2.5 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Available
	R5F564MFCDLJ	PTLG0100JA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Not supported
	R5F564MFDDLJ	PTLG0100JA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Not supported	Available
	R5F564MFGDLJ	PTLG0100JA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Not supported
	R5F564MFHDLJ	PTLG0100JA-A	2 Mbytes	512 Kbytes	64 Kbytes	120 MHz	Available	Available

1.3 Block Diagram

Figure 1.2 shows a block diagram.

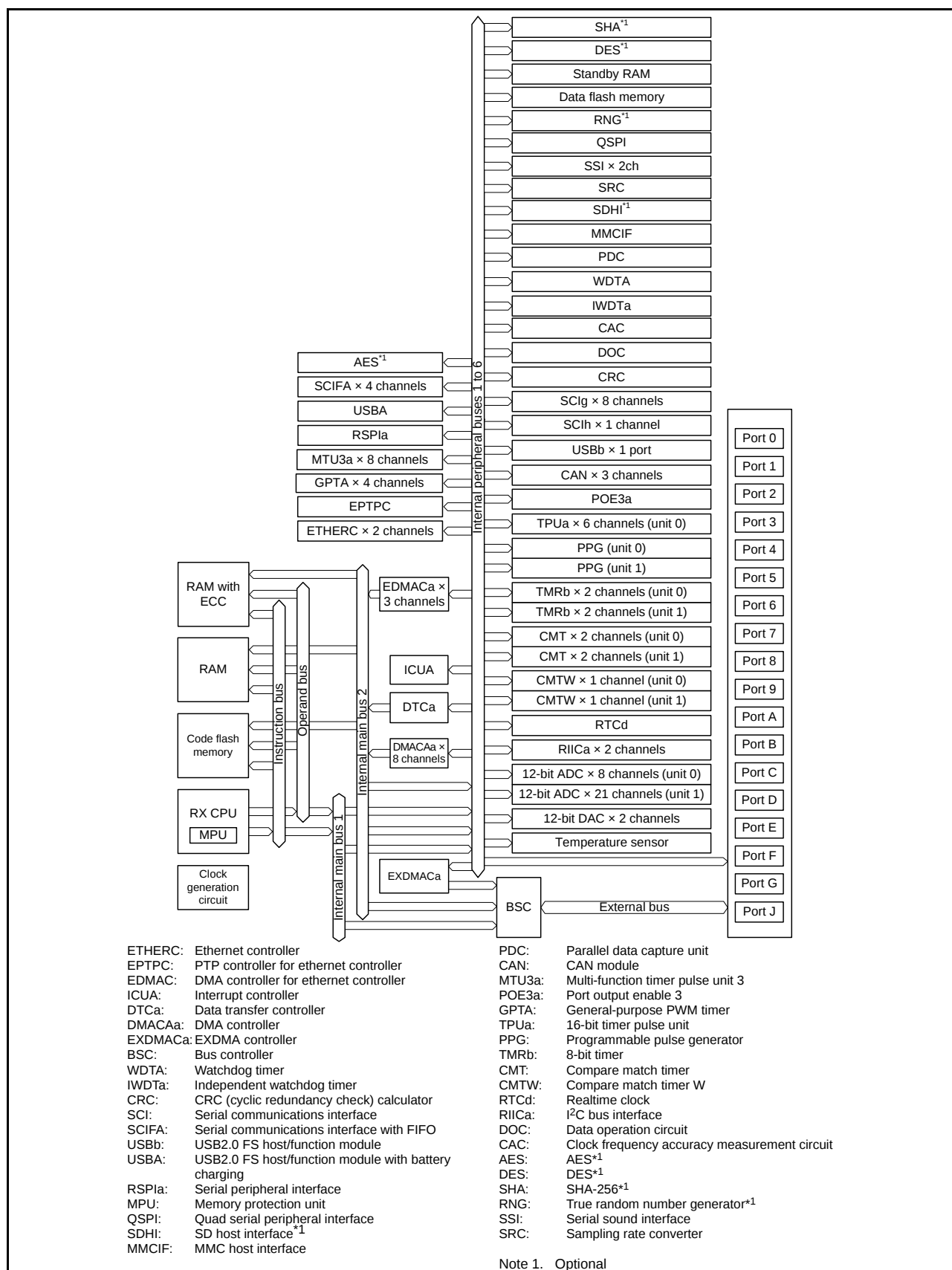


Figure 1.2 Block Diagram

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (6/7)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
143		PD7	D7[A7/D7]	MTIC5U/POE0#		MMC_D1-B/ SDHI_D1-B/ QIO1-B/QMI-B	IRQ7	AN107
144		PG1	D25		ET1_RX_ER/ RMII1_RX_ER			
145		PD6	D6[A6/D6]	MTIC5V/MTIOC8A/ POE4#		MMC_D0-B/ SDHI_D0-B/ QIO0-B/ QMO-B	IRQ6	AN106
146		PG0	D24		ET1_RX_CLK/ REF50CK1			
147		PD5	D5[A5/D5]	MTIC5W/MTIOC8C/ POE10#		MMC_CLK-B/ SDHI_CLK-B/ QSPCLK-B	IRQ5	AN113
148		PD4	D4[A4/D4]	MTIOC8B/POE11#		MMC_CMD-B/ SDHI_CMD-B/ QSSL-B	IRQ4	AN112
149		P97	A23/D23		ET1_ERXD3			
150		PD3	D3[A3/D3]	MTIOC8D/ GTIOC0A-E/POE8#/ TOC2		MMC_D3-B/ SDHI_D3-B/ QIO3-B	IRQ3	AN111
151	VSS							
152		P96	A22/D22		ET1_ERXD2			
153	VCC							
154		PD2	D2[A2/D2]	MTIOC4D/ GTIOC0B-E/TIC2	CRX0	MMC_D2-B/ SDHI_D2-B/ QIO2_B	IRQ2	AN110
155		P95	A21/D21		ET1_ERXD1/ RMII1_RXD1			
156		PD1	D1[A1/D1]	MTIOC4B/ GTIOC1A-E/POE0#	CTX0		IRQ1	AN109
157		P94	A20/D20		ET1_ERXD0/ RMII1_RXD0			
158		PD0	D0[A0/D0]	GTIOC1B-E/POE4#			IRQ0	AN108
159		P93	A19/D19	POE0#	ET1_LINKSTA/CTS7#/ RTS7#/SS7#			AN117
160		P92	A18/D18	POE4#	ET1_CRS/ RMII1_CRS_DV/ RXD7/SMISO7/SSCL7			AN116
161		P91	A17/D17		ET1_COL/SCK7			AN115
162	VSS							
163		P90	A16/D16		ET1_RX_DV/ TXD7/SMOSI7/SSDA7			AN114
164	VCC							
165		P47					IRQ15- DS	AN007
166		P46					IRQ14- DS	AN006
167		P45					IRQ13- DS	AN005
168		P44					IRQ12- DS	AN004
169		P43					IRQ11-DS	AN003
170		P42					IRQ10- DS	AN002
171		P41					IRQ9-DS	AN001
172	VREFL0							

Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (4/4)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
H9		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/ET0_ETXD1/ RMII0_TXD1			
H10		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/ET0_CRS/ RMII0_CRS_DV			
J1		P24	CS4#/ EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/ USB0_VBUSEN/ SSISCK1			
J2		P21		MTIOC1B/MTIOC4A/ GTIOC2A-B/TIOCA3/ TMC10/PO1	RXD0/SMISO0/ SSCL0/ USB0_EXICEN/ SSIWS0		IRQ9	
J3		P17		MTIOC3A/MTIOC3B/ MTIOC4B/GTIOC0B- B/TIOCB0/TCLKD/ TMO1/PO15/POE8#	SCK1/TXD3/SMOSI3/ SSDA3/SDA2-DS/ SSITXD0		IRQ7	ADTRG1#
J4		P13		MTIOC0B/TIOCA5/ TMO3/PO13	TXD2/SMOSI2/ SSDA2/SDA0[FM+]		IRQ3	ADTRG1#
J5	VSS_USB							
J6	VCC_USB							
J7		P50	WR0#/WR#		TXD2/SMOSI2/SSDA2			
J8		PC4	A20/CS3#	MTIOC3D/MTCLKC/ GTETRQ-D/TMC11/ PO25/POE0#	SCK5/CTS8#/SSLA0- A/ET0_TX_CLK			
J9		PC0	A16	MTIOC3C/TCLKC/ PO17	CTS5#/RTS5#/SS5#/ SSLA1-A/ET0_ERXD3		IRQ14	
J10		PC1	A17	MTIOC3A/TCLKD/ PO18	SCK5/SSLA2-A/ ET0_ERXD2		IRQ12	
K1		P23	EDACK0	MTIOC3D/MTCLKD/ GTIOC0A-B/TIOC0D3/ PO3	TXD3/CTS0#/RTS0#/ SMOSI3/SS0#/ SSDA3/SSISCK0			
K2		P22	EDREQ0	MTIOC3B/MTCLKC/ GTIOC1A-B/TIOCC3/ TMO0/PO2	SCK0/ USB0_OVRCURB/ AUDIO_MCLK			
K3		P20		MTIOC1A/TIOCB3/ TMRI0/PO0	TXD0/SMOSI0/ SSDA0/USB0_ID/ SSIRXD0		IRQ8	
K4		P14		MTIOC3A/MTCLKA/ TIOCB5/TCLKA/ TMRI2/PO15	CTS1#/RTS1#/SS1#/ CTX1/ USB0_OVRCURA		IRQ4	
K5					USB0_DM			
K6					USB0_DP			
K7		P51	WR1#/BC1#/ WAIT#		SCK2			
K8		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/ GTIOC1A-D/TMRI2/ PO29	SCK8/RSPCKA-A/ RTS8#/ET0_ETXD2			
K9		PC3	A19	MTIOC4D/GTIOC1B- D/TCLKB/PO24	TXD5/SMOSI5/ SSDA5/ET0_TX_ER			
K10		PC2	A18	MTIOC4B/GTIOC2B- D/TCLKA/PO21	RXD5/SMISO5/ SSCL5/SSLA3-A/ ET0_RX_DV			

Note 1. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

2.1 General-Purpose Registers (R0 to R15)

This CPU has sixteen 32-bit general-purpose registers (R0 to R15). R0 to R15 can be used as data registers or address registers.

R0, a general-purpose register, also functions as the stack pointer (SP).

The stack pointer is switched to operate as the interrupt stack pointer (ISP) or user stack pointer (USP) by the value of the stack pointer select bit (U) in the processor status word (PSW).

2.2 Control Registers

(1) Interrupt Stack Pointer (ISP) / User Stack Pointer (USP)

The stack pointer (SP) can be either of two types, the interrupt stack pointer (ISP) or the user stack pointer (USP).

Whether the stack pointer operates as the ISP or USP depends on the value of the stack pointer select bit (U) in the processor status word (PSW).

(2) Exception Table Register (EXTB)

The exception table register (EXTB) specifies the address where the exception vector table starts.

(3) Interrupt Table Register (INTB)

The interrupt table register (INTB) specifies the address where the interrupt vector table starts.

(4) Program Counter (PC)

The program counter (PC) indicates the address of the instruction being executed.

(5) Processor Status Word (PSW)

The processor status word (PSW) indicates the results of instruction execution or the state of the CPU.

(6) Backup PC (BPC)

The backup PC (BPC) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the program counter (PC) are saved in the BPC register.

(7) Backup PSW (BPSW)

The backup PSW (BPSW) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the processor status word (PSW) are saved in the BPSW. The allocation of bits in the BPSW corresponds to that in the PSW.

(8) Fast Interrupt Vector Register (FINTV)

The fast interrupt vector register (FINTV) is provided to speed up response to interrupts.

The FINTV register specifies a branch destination address when a fast interrupt has been generated.

(9) Floating-Point Status Word (FPSW)

The floating-point status word (FPSW) indicates the results of floating-point operations.

When an exception handling enable bit (Ej) enables the exception handling ($E_j = 1$), the exception cause can be identified by checking the corresponding Cj flag in the exception handling routine. If the exception handling is masked ($E_j = 0$), the occurrence of exception can be checked by reading the Fj flag at the end of a series of processing. Once the Fj flag has been set to 1, this value is retained until it is cleared to 0 by software ($j = X, U, Z, O, \text{ or } V$).

Table 4.1 List of I/O Registers (Address Order) (3 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK $\geq$ PCLK	ICLK $<$ PCLK	
0008 12C3h	ECCRAM	ECCRAM 1-Bit Error Status Register	ECCRAM1STS	8	8	2 ICLK		RAM
0008 12C4h	ECCRAM	ECCRAM Protection Register	ECCRAMPRCR	8	8	2 ICLK		RAM
0008 12C8h	ECCRAM	ECCRAM 2-Bit Error Address Capture Register	ECCRAM2ECAD	32	32	2 ICLK		RAM
0008 12CCh	ECCRAM	ECCRAM 1-Bit Error Address Capture Register	ECCRAM1ECAD	32	32	2 ICLK		RAM
0008 12D0h	ECCRAM	ECCRAM Protection Register 2	ECCRAMPRCR2	8	8	2 ICLK		RAM
0008 12D4h	ECCRAM	ECCRAM Test Control Register	ECCRAMETST	8	8	2 ICLK		RAM
0008 1300h	BSC	Bus Error Status Clear Register	BERCLR	8	8	2 ICLK		Buses
0008 1304h	BSC	Bus Error Monitoring Enable Register	BEREN	8	8	2 ICLK		Buses
0008 1308h	BSC	Bus Error Status Register 1	BERSR1	8	8	2 ICLK		Buses
0008 130Ah	BSC	Bus Error Status Register 2	BERSR2	16	16	2 ICLK		Buses
0008 1310h	BSC	Bus Priority Control Register	BUSPRI	16	16	2 ICLK		Buses
0008 2000h	DMAC0	DMA Source Address Register	DMSAR	32	32	2 ICLK		DMACaA
0008 2004h	DMAC0	DMA Destination Address Register	DMDAR	32	32	2 ICLK		DMACaA
0008 2008h	DMAC0	DMA Transfer Count Register	DMCRA	32	32	2 ICLK		DMACaA
0008 200Ch	DMAC0	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK		DMACaA
0008 2010h	DMAC0	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK		DMACaA
0008 2013h	DMAC0	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK		DMACaA
0008 2014h	DMAC0	DMA Address Mode Register	DMAMD	16	16	2 ICLK		DMACaA
0008 2018h	DMAC0	DMA Offset Register	DMOFR	32	32	2 ICLK		DMACaA
0008 201Ch	DMAC0	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK		DMACaA
0008 201Dh	DMAC0	DMA Software Start Register	DMREQ	8	8	2 ICLK		DMACaA
0008 201Eh	DMAC0	DMA Status Register	DMSTS	8	8	2 ICLK		DMACaA
0008 201Fh	DMAC0	DMA Request Source Flag Control Register	DMCSL	8	8	2 ICLK		DMACaA
0008 2040h	DMAC1	DMA Source Address Register	DMSAR	32	32	2 ICLK		DMACaA
0008 2044h	DMAC1	DMA Destination Address Register	DMDAR	32	32	2 ICLK		DMACaA
0008 2048h	DMAC1	DMA Transfer Count Register	DMCRA	32	32	2 ICLK		DMACaA
0008 204Ch	DMAC1	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK		DMACaA
0008 2050h	DMAC1	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK		DMACaA
0008 2053h	DMAC1	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK		DMACaA
0008 2054h	DMAC1	DMA Address Mode Register	DMAMD	16	16	2 ICLK		DMACaA
0008 205Ch	DMAC1	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK		DMACaA
0008 205Dh	DMAC1	DMA Software Start Register	DMREQ	8	8	2 ICLK		DMACaA
0008 205Eh	DMAC1	DMA Status Register	DMSTS	8	8	2 ICLK		DMACaA
0008 205Fh	DMAC1	DMA Request Source Flag Control Register	DMCSL	8	8	2 ICLK		DMACaA
0008 2080h	DMAC2	DMA Source Address Register	DMSAR	32	32	2 ICLK		DMACaA
0008 2084h	DMAC2	DMA Destination Address Register	DMDAR	32	32	2 ICLK		DMACaA
0008 2088h	DMAC2	DMA Transfer Count Register	DMCRA	32	32	2 ICLK		DMACaA
0008 208Ch	DMAC2	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK		DMACaA
0008 2090h	DMAC2	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK		DMACaA
0008 2093h	DMAC2	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK		DMACaA
0008 2094h	DMAC2	DMA Address Mode Register	DMAMD	16	16	2 ICLK		DMACaA
0008 209Ch	DMAC2	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK		DMACaA
0008 209Dh	DMAC2	DMA Software Start Register	DMREQ	8	8	2 ICLK		DMACaA
0008 209Eh	DMAC2	DMA Status Register	DMSTS	8	8	2 ICLK		DMACaA
0008 209Fh	DMAC2	DMA Request Source Flag Control Register	DMCSL	8	8	2 ICLK		DMACaA
0008 20C0h	DMAC3	DMA Source Address Register	DMSAR	32	32	2 ICLK		DMACaA

Table 4.1 List of I/O Registers (Address Order) (19 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK $\geq$ PCLK	ICLK < PCLK	
0008 9090h	S12AD	A/D Compare Control Register	ADCMPCR	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9094h	S12AD	A/D Compare Channel Select Register 0	ADCMPSR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9098h	S12AD	A/D Compare Level Register 0	ADCMPLR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 909Ch	S12AD	A/D Compare Data Register 0	ADCMPDR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 909Eh	S12AD	A/D Compare Data Register 1	ADCMPDR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 90A0h	S12AD	A/D Compare Status Register 0	ADCMPSR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9100h	S12AD1	A/D Control Register	ADCSR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9104h	S12AD1	A/D Channel Select Register A0	ADANSA0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9106h	S12AD1	A/D Channel Select Register A1	ADANSA1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9108h	S12AD1	A/D-Converted Value Addition/Average Mode Select Register 0	ADADS0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 910Ah	S12AD1	A/D-Converted Value Addition/Average Mode Select Register 1	ADADS1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 910Ch	S12AD1	A/D-Converted Value Addition/Average Count Select Register	ADADC	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 910Eh	S12AD1	A/D Control Extended Register	ADCER	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9110h	S12AD1	A/D Start Trigger Select Register	ADSTRGR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9112h	S12AD1	A/D Conversion Extended Input Control Register	ADEXICR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9114h	S12AD1	A/D Channel Select Register B0	ADANSB0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9116h	S12AD1	A/D Channel Select Register B1	ADANSB1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9118h	S12AD1	A/D Data Duplication Register	ADDBLDR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 911Ah	S12AD1	A/D Temperature Sensor Data Register	ADTSDR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 911Ch	S12AD1	A/D Internal Reference Voltage Data Register	ADOCDR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 911Eh	S12AD1	A/D Self-Diagnosis Data Register	ADRD	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9120h	S12AD1	A/D Data Register 0	ADDR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9122h	S12AD1	A/D Data Register 1	ADDR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9124h	S12AD1	A/D Data Register 2	ADDR2	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9126h	S12AD1	A/D Data Register 3	ADDR3	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9128h	S12AD1	A/D Data Register 4	ADDR4	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 912Ah	S12AD1	A/D Data Register 5	ADDR5	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 912Ch	S12AD1	A/D Data Register 6	ADDR6	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 912Eh	S12AD1	A/D Data Register 7	ADDR7	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9130h	S12AD1	A/D Data Register 8	ADDR8	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9132h	S12AD1	A/D Data Register 9	ADDR9	16	16	2, 3 PCLKB	2 ICLK	S12ADC

Table 4.1 List of I/O Registers (Address Order) (26 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A0C7h	SCI6	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0C8h	SCI6	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0C9h	SCI6	I ² C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CAh	SCI6	I ² C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CBh	SCI6	I ² C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CCh	SCI6	I ² C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CDh	SCI6	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CEh	SCI6	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CFh	SCI6	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0CEh	SCI6	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h
0008 A0D0h	SCI6	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0D1h	SCI6	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0D0h	SCI6	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h
0008 A0D2h	SCI6	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E0h	SCI7	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E1h	SCI7	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E2h	SCI7	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E3h	SCI7	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E4h	SCI7	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E5h	SCI7	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E6h	SMCI7	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E7h	SCI7	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E8h	SCI7	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0E9h	SCI7	I ² C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EAh	SCI7	I ² C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EBh	SCI7	I ² C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0ECh	SCI7	I ² C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EDh	SCI7	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EEh	SCI7	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EFh	SCI7	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h
0008 A0EEh	SCI7	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h

Table 4.1 List of I/O Registers (Address Order) (38 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C2A0h to 0008 C2BFh	SYSTEM	Deep Standby Backup Registers 0 to 31	DPSBKR0 to 31	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C400h	RTC	64-Hz Counter	R64CNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C402h	RTC	Second Counter	RSECCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C402h	RTC	Binary Counter 0	BCNT0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C404h	RTC	Minute Counter	RMINCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C404h	RTC	Binary Counter 1	BCNT1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C406h	RTC	Hour Counter	RHRCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C406h	RTC	Binary Counter 2	BCNT2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C408h	RTC	Day-of-Week Counter	RWKCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C408h	RTC	Binary Counter 3	BCNT3	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Ah	RTC	Date Counter	RDAYCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Ch	RTC	Month Counter	RMONCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Eh	RTC	Year Counter	RYRCNT	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C410h	RTC	Second Alarm Register	RSECAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C410h	RTC	Binary Counter 0 Alarm Register	BCNT0AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C412h	RTC	Minute Alarm Register	RMINAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C412h	RTC	Binary Counter 1 Alarm Register	BCNT1AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C414h	RTC	Hour Alarm Register	RHRAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C414h	RTC	Binary Counter 2 Alarm Register	BCNT2AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C416h	RTC	Day-of-Week Alarm Register	RWKAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C416h	RTC	Binary Counter 3 Alarm Register	BCNT3AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C418h	RTC	Date Alarm Register	RDAYAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C418h	RTC	Binary Counter 0 Alarm Enable Register	BCNT0AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ah	RTC	Month Alarm Register	RMONAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ah	RTC	Binary Counter 1 Alarm Enable Register	BCNT1AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ch	RTC	Year Alarm Register	RYRAR	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ch	RTC	Binary Counter 2 Alarm Enable Register	BCNT2AER	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Eh	RTC	Year Alarm Enable Register	RYRAREN	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Eh	RTC	Binary Counter 3 Alarm Enable Register	BCNT3AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C422h	RTC	RTC Control Register 1	RCR1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C424h	RTC	RTC Control Register 2	RCR2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C426h	RTC	RTC Control Register 3	RCR3	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C428h	RTC	RTC Control Register 4	RCR4	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Ah	RTC	Frequency Register H	RFRH	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Ch	RTC	Frequency Register L	RFRL	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Eh	RTC	Time Error Adjustment Register	RADJ	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C440h	RTC	Time Capture Control Register 0	RTCCR0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C442h	RTC	Time Capture Control Register 1	RTCCR1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C444h	RTC	Time Capture Control Register 2	RTCCR2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C452h	RTC	Second Capture Register 0	RSECCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C452h	RTC	BCNT0 Capture Register 0	BCNT0CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C454h	RTC	Minute Capture Register 0	RMINCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C454h	RTC	BCNT1 Capture Register 0	BCNT1CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C456h	RTC	Hour Capture Register 0	RHRCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C456h	RTC	BCNT2 Capture Register 0	BCNT2CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ah	RTC	Date Capture Register 0	RDAYCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ah	RTC	BCNT3 Capture Register 0	BCNT3CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ch	RTC	Month Capture Register 0	RMONCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd

Table 4.1 List of I/O Registers (Address Order) (66 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000D 049Ch	USBA	Pipe4 Transaction Counter Enable Register	PIPE4TRE	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 049Eh	USBA	Pipe4 Transaction Counter Register	PIPE4TRN	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04A0h	USBA	Pipe5 Transaction Counter Enable Register	PIPE5TRE	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04A2h	USBA	Pipe5 Transaction Counter Register	PIPE5TRN	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04D0h	USBA	Device Address 0 Configuration Register	DEVADD0	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04D2h	USBA	Device Address 1 Configuration Register	DEVADD1	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04D4h	USBA	Device Address 2 Configuration Register	DEVADD2	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04D6h	USBA	Device Address 3 Configuration Register	DEVADD3	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04D8h	USBA	Device Address 4 Configuration Register	DEVADD4	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 04DAh	USBA	Device Address 5 Configuration Register	DEVADD5	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 0500h	USBA	Low Power Control Register	LPCTRL	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 0502h	USBA	Low Power Status Register	LPSTS	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 0540h	USBA	Battery Charging Control Register	BCCTRL	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 0544h	USBA	Function L1 Control Register 1	PL1CTRL1	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA
000D 0546h	USBA	Function L1 Control Register 2	PL1CTRL2	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/ PCLKB) ^{*5}	USBA

Table 5.3 DC Characteristics (2)

Conditions: $V_{CC} = AV_{CC0} = AV_{CC1} = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq V_{REFH0} \leq AV_{CC0}$,
 $V_{CC_USBA} = AV_{CC_USBA} = 3.0$ to 3.6 V,
 $V_{SS} = AV_{SS0} = AV_{SS1} = V_{REFL0} = V_{SS_USB} = V_{SS1_USBA} = V_{SS2_USBA} = PV_{SS_USBA} = AV_{SS_USBA} = 0$ V,
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Output high voltage	All output pins	V _{OH}	VCC – 0.5	—	—	V	I _{OH} = –1 mA
Output low voltage	All output pins (except for RIIC pins and ETHERC output pin)	V _{OL}	—	—	0.5	V	I _{OL} = 1.0 mA
	RIIC output pin		—	—	0.4		I _{OL} = 3.0 mA
			—	—	0.6		I _{OL} = 6.0 mA
	RIIC output pin (only P12 and P13 in channel 0)	V _{OL}	—	—	0.4	V	I _{OL} = 15.0 mA (ICFER.FMPE = 1)
			—	0.4	—		I _{OL} = 20.0 mA (ICFER.FMPE = 1)
	ETHERC output pin	V _{OL}	—	—	0.4	V	I _{OL} = 1.0 mA
Input leakage current	RES#, MD pin, EMLE*1, BSCANP*1, NMI	I _{in}	—	—	1.0	μA	V _{in} = 0 V V _{in} = VCC
Three-state leakage current (off state)	Other than ports for 5 V tolerant	I _{TSI}	—	—	1.0	μA	V _{in} = 0 V V _{in} = VCC
	Ports for 5 V tolerant		—	—	5.0		V _{in} = 0 V V _{in} = 5.5 V
Input pull-up MOS current	Ports 0 to 2, 30 to 34, 36, 37, 4 to G, J3, J5	I _p	–300	—	–10	μA	VCC = 2.7 to 3.6 V V _{in} = 0 V
Input pull-down MOS current	EMLE, BSCANP	I _p	10	—	300	μA	V _{in} = VCC
Input capacitance	All input pins (except for ports 03, 05, 12, 13, 16, 17, EMLE, BSCANP, USB0_DP, USB0_DM, USBA_DP, and USBA_DM)	C _{in}	—	—	8	pF	V _{bias} = 0 V V _{amp} = 20 mV f = 1 MHz T _a = 25°C
	Ports 03, 05, 12, 13, 16, 17, EMLE, BSCANP, USB0_DP, USB0_DM, USBA_DP, and USBA_DM		—	—	16		

Note 1. The input leakage current value at the EMLE and BSCANP pins are only when $V_{in} = 0$ V.

Table 5.5 DC Characteristics (4)

Conditions: $V_{CC} = AVCC0 = AVCC1 = VREFH0 = VCC_USB = 2.7$ to 3.6 V, $2.7 \leq VREFH0 \leq AVCC0$,
 $VCC_USBA = AVCC_USBA = 3.0$ to 3.6 V,
 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0$ V,
 $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog power supply current*1	During 12-bit A/D conversion (unit 0)		I _{ACC}	—	0.7	1.0	mA	IAVCC0_AD
	During 12-bit A/D conversion (unit 0) with the channel-dedicated sample-and-hold circuits for 3 channels operating			—	1.7	2.5	mA	IAVCC0_AD+SH
	During 12-bit A/D conversion (unit 1)			—	0.6	1.0	mA	IAVCC1_AD
	During 12-bit A/D conversion (unit 1) with the temperature sensor operating			—	0.7	1.1	mA	IAVCC1_AD+TEMP
	During D/A conversion (per unit)	Without AMP output		—	0.24	0.4	mA	IAVCC1_DA
		With AMP output		—	0.4	0.7	mA	
	Waiting for A/D, D/A, or temperature sensor conversion (all units)			—	0.9	1.4	mA	IAVCC0 + IAVCC1
	A/D, D/A converter, temperature sensor in standby mode (all units)			—	1.3	3.0	μA	IAVCC0 + IAVCC1
Reference power supply current	During 12-bit A/D conversion (unit 0)		I _{REFH}	—	70	120	μA	IVREFH0
	Waiting for 12-bit A/D conversion (unit 0)			—	0.07	0.4	μA	IVREFH0
	12-bit A/D converter in standby mode (unit 0)			—	0.07	0.2	μA	IVREFH0
USB operating current	Low speed	USB0	I _{CCUSBLS}	—	3.5	6.5	mA	VCC_USB
		USBA		—	8.5	12.0	mA	VCC_USBA = AVCC_USBA (PHYSET.HSEB = 0)
		USBA		—	2.8	3.6	mA	VCC_USBA = AVCC_USBA (PHYSET.HSEB = 1)
	Full speed	USB0	I _{CCUSBFS}	—	4.0	10.0	mA	VCC_USB
		USBA		—	12.0	20.0	mA	VCC_USBA = AVCC_USBA (PHYSET.HSEB = 0)
		USBA		—	6.5	13.0	mA	VCC_USBA = AVCC_USBA (PHYSET.HSEB = 1)
	Standby mode (direct power down)	USBA	I _{CCUSBSBY}	—	0.1	3.0	μA	VCC_USBA = AVCC_USBA
RAM standby voltage			V _{RAM}	2.7	—	—	V	
VCC rising gradient			SrVCC	8.4	—	20000	μs/V	
VCC falling gradient*2			SfVCC	8.4	—	—	μs/V	

Note 1. The reference power supply current is included in the power supply current value for 12-bit A/D conversion (unit 1) and D/A conversion.

Note 2. This applies when V_{BATT} is used.

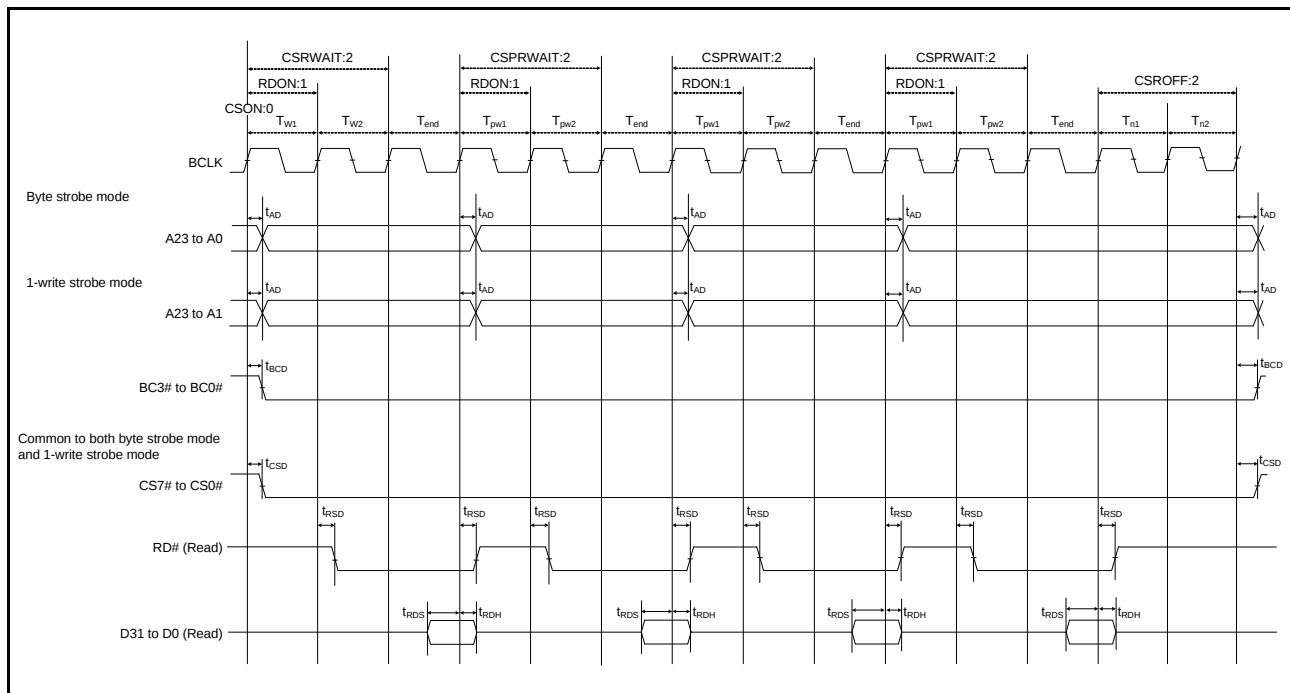


Figure 5.20 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

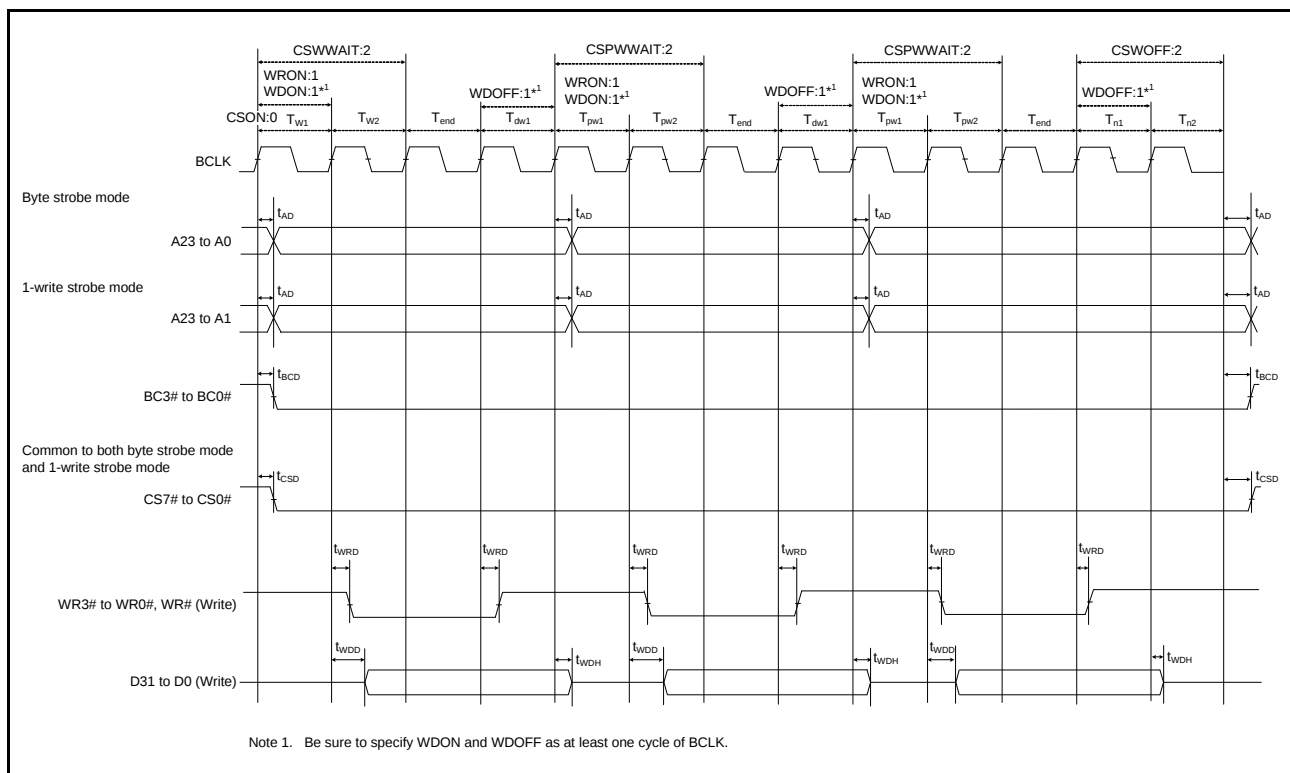


Figure 5.21 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

Table 5.32 SCI and SCIF Timing

Conditions: $V_{CC} = AVCC0 = AVCC1 = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq V_{REFH0} \leq AVCC0$,
 $V_{CC_USBA} = AVCC_USBA = 3.0$ to 3.6 V,
 $V_{SS} = AVSS0 = AVSS1 = V_{REFL0} = V_{SS_USB} = V_{SS1_USBA} = V_{SS2_USBA} = PVSS_USBA = AVSS_USBA = 0$ V,
 $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$
Output load conditions: $V_{OH} = V_{CC} \times 0.5$, $V_{OL} = V_{CC} \times 0.5$, $C = 30$ pF
High-drive output is selected by the driving ability control register.

Item			Symbol	Min.*1	Max.*1	Unit*1	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PBcyc}	Figure 5.44
		Clock synchronous		6	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*2	t_{Scyc}	8	—	t_{PBcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Clock synchronous	t_{TXD}	—	28	ns	Figure 5.45
	Receive data setup time	Clock synchronous	t_{RXS}	15	—	ns	
	Receive data hold time	Clock synchronous	t_{RXH}	5	—	ns	
SCIF	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PAcyc}	Figure 5.44
		Clock synchronous		12	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*3	t_{Scyc}	8	—	t_{PAcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Master	t_{TXD}	—	10	ns	Figure 5.45
		Slave		—	$4 \times t_{PAcyc} + 20$		
	Receive data setup time	Master	t_{RXS}	$3 \times t_{PAcyc} + 20$	—	ns	
		Slave		$t_{PAcyc} + 10$	—		
	Receive data hold time	Master	t_{RXH}	$-3 \times t_{PAcyc} + 5$	—	ns	
		Slave		$2 \times t_{PAcyc} + 10$	—		

Note 1. t_{PBcyc} : PCLKB cycle; t_{PAcyc} : PCLKA cycle

Note 2. When the SEMR.ABCS and SEMR.BGDM bits are set to 1

Note 3. When the SEMR.ABCS0 and SEMR.BGDM bits are set to 1

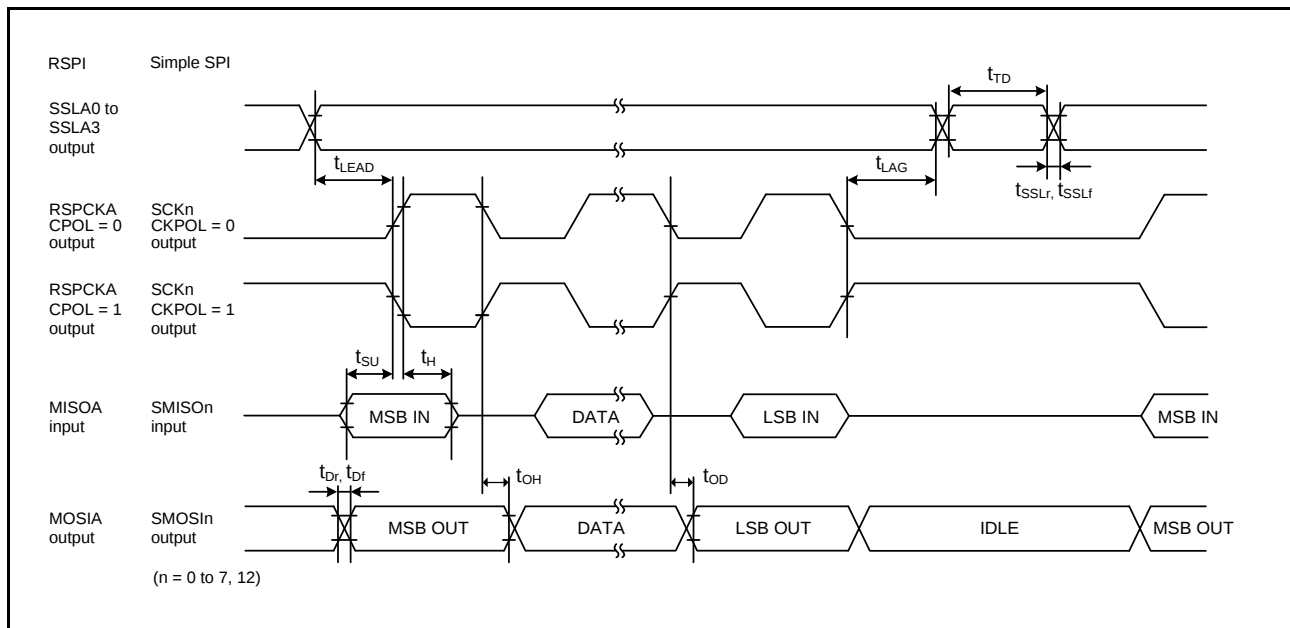


Figure 5.47 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Division Ratio Set to a Value Other Than 1/2) and Simple SPI Timing (Master, CKPH = 1)

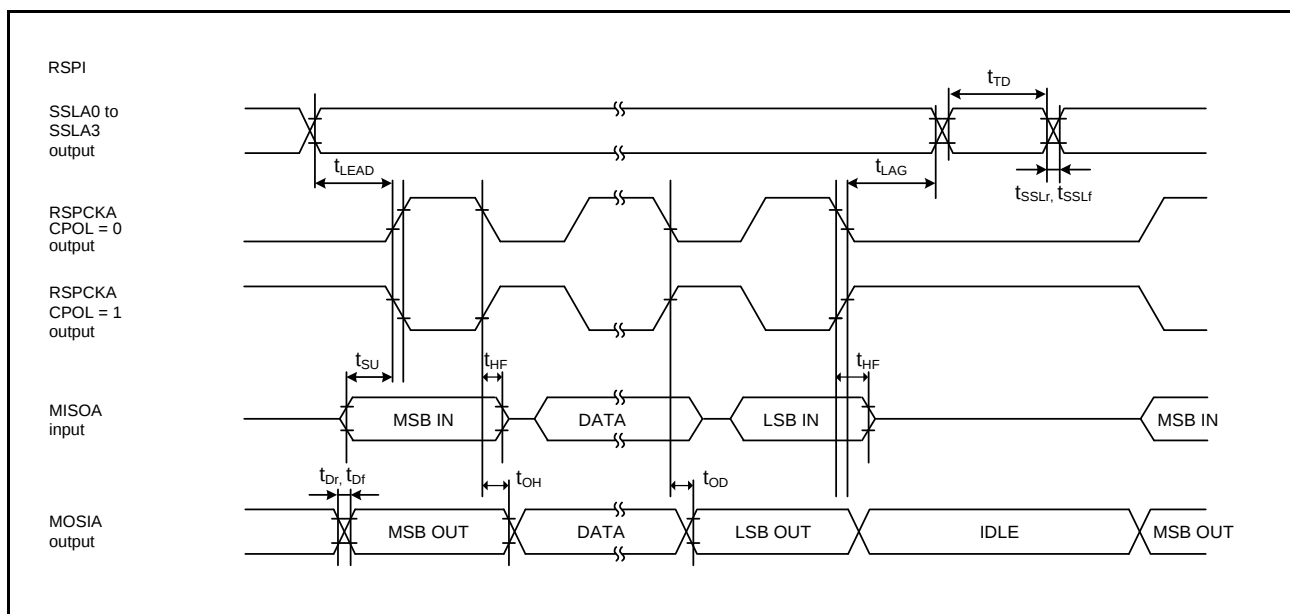


Figure 5.48 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Division Ratio Set to 1/2)

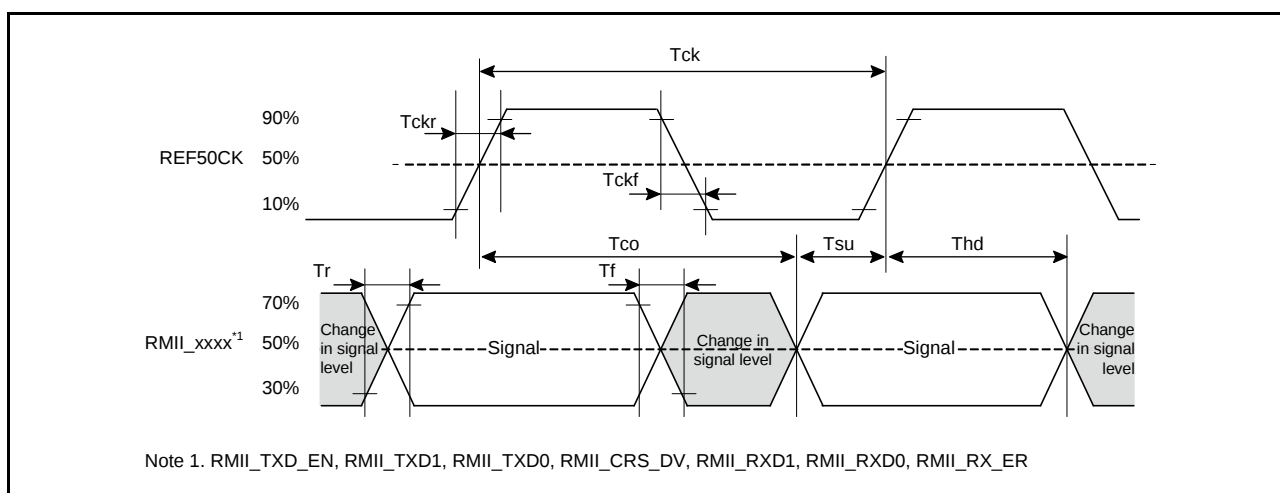


Figure 5.62 Timing with the REF50CK and RMII Signals

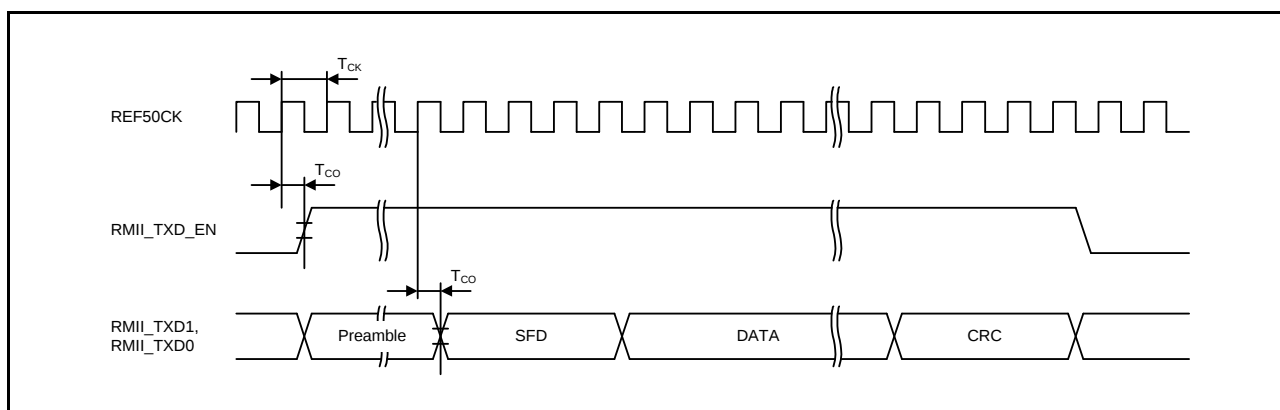


Figure 5.63 RMII Transmission Timing

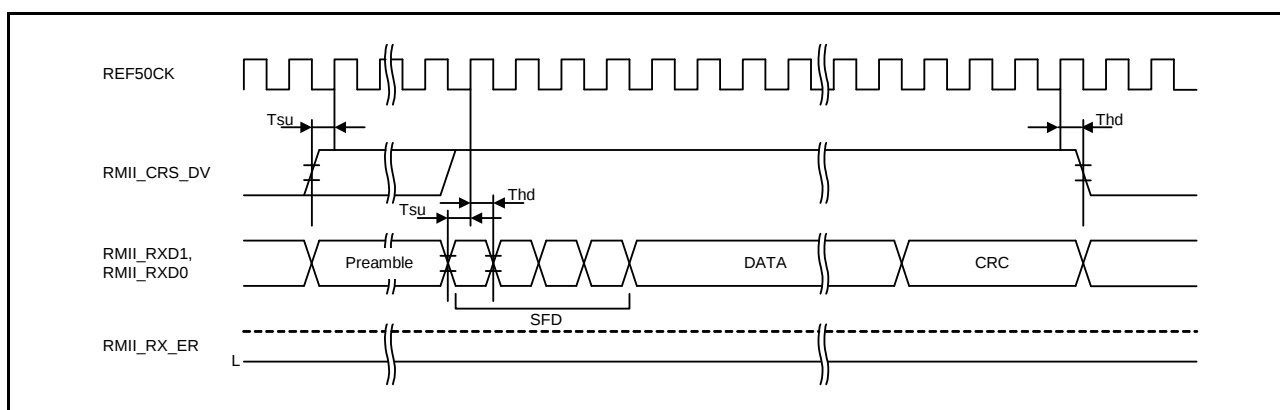


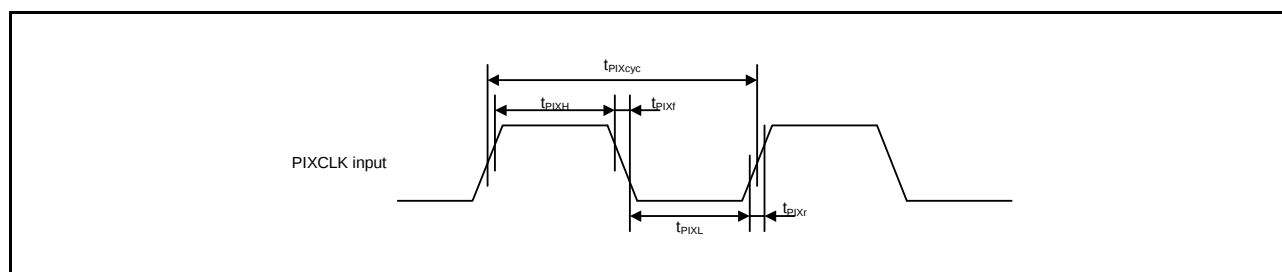
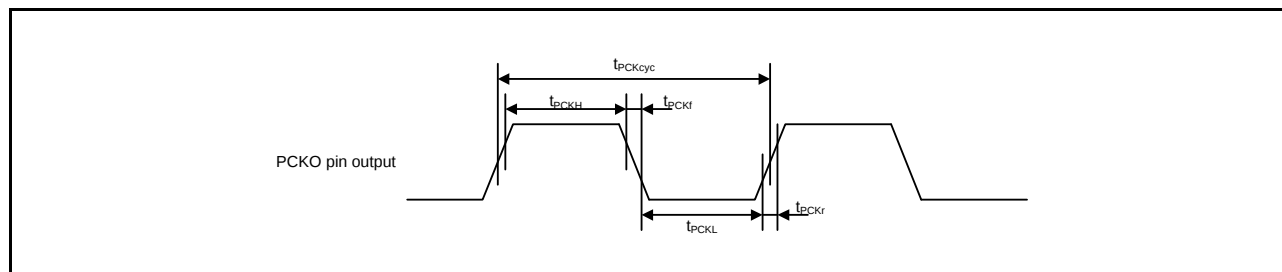
Figure 5.64 RMII Reception Timing (Normal Operation)

Table 5.41 PDC Timing

Conditions: $V_{CC} = AVCC0 = AVCC1 = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq V_{REFH0} \leq AVCC0$,
 $V_{CC_USBA} = AVCC_USBA = 3.0$ to 3.6 V,
 $V_{SS} = AVSS0 = AVSS1 = V_{REFL0} = V_{SS_USB} = V_{SS1_USBA} = V_{SS2_USBA} = PV_{SS_USBA} = AVSS_USBA = 0$ V,
 $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$
 Output load conditions: $V_{OH} = V_{CC} \times 0.5$, $V_{OL} = V_{CC} \times 0.5$, $C = 30$ pF
 High-drive output is selected by the driving ability control register.

Item	Symbol	Min.*1	Max.	Unit	Test Conditions
PDC	PIXCLK input cycle time	t_{PIXcyc}	37	ns	Figure 5.72
	PIXCLK input high pulse width	t_{PIXH}	10	ns	
	PIXCLK input low pulse width	t_{PIXL}	10	ns	
	PIXCLK rising time	t_{PIXr}	5	ns	
	PIXCLK falling time	t_{PIXf}	5	ns	
	PCKO output cycle time	t_{PCKcyc}	$2 \times t_{PBcyc}$	ns	Figure 5.73
	PCKO output high pulse width	t_{PCKH}	$(t_{PCKcyc} - t_{PCKr} - t_{PCKf})/2 - 3$	ns	
	PCKO output low pulse width	t_{PCKL}	$(t_{PCKcyc} - t_{PCKr} - t_{PCKf})/2 - 3$	ns	
	PCKO rising time	t_{PCKr}	5	ns	
	PCKO falling time	t_{PCKf}	5	ns	
	VSYNV/HSYNC input setup time	t_{SYNCS}	10	ns	Figure 5.74
	VSYNV/HSYNC input hold time	t_{SYNCH}	5	ns	
	PIXD input setup time	t_{PIXDS}	10	ns	
	PIXD input hold time	t_{PIXDH}	5	ns	

Note 1. t_{PBcyc} : PCLKB cycle

**Figure 5.72 PDC Input Clock Timing****Figure 5.73 PDC Output Clock Timing**

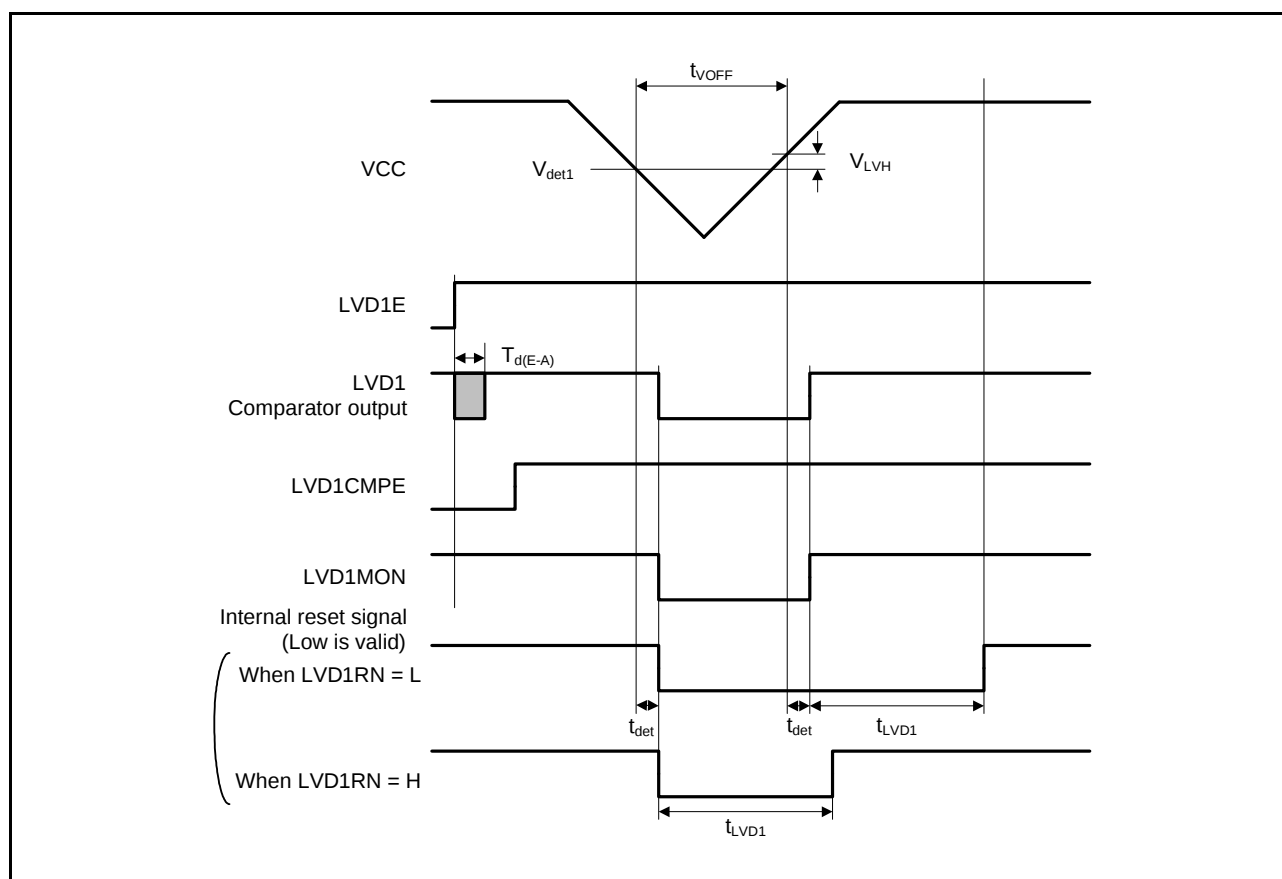


Figure 5.81 Voltage Detection Circuit Timing (V_{det1})

Table 5.54 Data Flash Memory Characteristics

Conditions: $V_{CC} = AVCC0 = AVCC1 = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq V_{REFH0} \leq AVCC0$,
 $V_{CC_USBA} = AVCC_USBA = 3.0$ to 3.6 V
 $V_{SS} = AVSS0 = AVSS1 = V_{REFL0} = V_{SS_USB} = V_{SS1_USBA} = V_{SS2_USBA} = PV_{SS_USBA} = AVSS_USBA = 0$ V,
 Temperature range for programming/erasure: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	4 bytes	t_{DP4}	—	0.36	3.8	—	0.16	1.7	ms
Erasure time	64 bytes	t_{DE64}	—	3.1	18	—	1.7	10	ms
Blank check time	4 bytes	t_{DBC4}	—	—	84	—	—	30	μs
	64 bytes	t_{DBC64}	—	—	280	—	—	100	μs
	2 Kbytes	t_{DBC2K}	—	—	6169	—	—	2200	μs
Reprogramming/erasure cycle*1		N_{DPEC}	100000 *2	—	—	100000 *2	—	—	—
Suspend delay time during programming		t_{DSPD}	—	—	264	—	—	120	μs
First suspend delay time during erasure (in suspend priority mode)		t_{DSESD1}	—	—	216	—	—	120	μs
Second suspend delay time during erasure (in suspend priority mode)		t_{DSESD2}	—	—	300	—	—	300	μs
Suspend delay time during erasing (in erasure priority mode)		t_{DSEED}	—	—	300	—	—	300	μs
Forced stop command		t_{FD}	—	—	32	—	—	20	μs
Data hold time*3		t_{DDRP}	10	—	—	10	—	—	—

Note 1. Definition of reprogram/erase cycle:

The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times ($n = 100000$), erasing can be performed n times for each block. For instance, when 4-byte programming is performed 512 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. This is the minimum number of times to guarantee all the characteristics after reprogramming (guaranteed range is from 1 to the value of the minimum value).

Note 3. This shows the characteristics when reprogramming is performed within the specified range, including the minimum value.

REVISION HISTORY	RX64M Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.90	Feb 28, 2014	—	First edition, issued
1.00	Jul 31, 2014	Summary	
		1	■ Data transfer, changed
		1. Overview	
		—	FINEC (Pin), deleted
		2	Table 1.1 Outline of Specifications (1/9), changed
		3	Table 1.1 Outline of Specifications (2/9), changed
		6	Table 1.1 Outline of Specifications (5/9), changed
		7	Table 1.1 Outline of Specifications (6/9), changed
		8	Table 1.1 Outline of Specifications (7/9), changed
		9	Table 1.1 Outline of Specifications (8/9), changed
		10	Table 1.1 Outline of Specifications (9/9), changed
		16	Figure 1.1 How to Read the Product Part Number, changed
		19	Table 1.4 Pin Functions (2/8), changed
		20	Table 1.4 Pin Functions (3/8), changed
		25	Table 1.4 Pin Functions (8/8), note added
		2. CPU, added	
		3. Address Space, added	
		4. I/O Registers, added	
		5. Electrical Characteristics, added	
		Appendix 1. Package Dimensions, added	

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.10	Oct 24, 2016	All	Terms unified: GPTa → GPTA LQFP → LFQFP	
		Features		
		1	AES key lengths, changed	TN-RX*-A122A/E
		1. Overview		
		2	Table 1.1 Outline of Specifications (1/9), changed	TN-RX*-A127A/E
		5	Table 1.1 Outline of Specifications (4/9), changed	
		10	Table 1.1 Outline of Specifications (9/9), changed	TN-RX*-A122A/E
		28	Figure 1.5 Pin Assignment (176-Pin LFQFP), changed	
		48	Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (2/5), changed	
		49	Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (3/5), changed	
		52	Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (1/5), changed	
		55	Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (4/5), changed	
		58	Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (2/4), changed	
		59	Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (3/4), changed	
		63	Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (3/4), changed	
		4. I/O Registers		
		71	(4) Notes on Sleep Mode and Mode Transitions, added	
		73	Table 4.1 List of I/O Registers (Address Order) (2 / 67) 0008 1200h, 0008 1201h, 0008 1204h, 0008 1208h, added	TN-RX*-A127A/E